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## Product Summary

$V_{BR}$ Min	$I_{PP}$ Max	$C_T$ Typ
21V	2A	7pF

## Description

This new generation TVS is designed to protect sensitive electronics from damage due to ESD. The combination of small-size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

## Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripherals

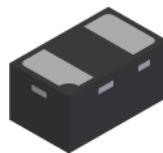
## Features

- Low Profile Package (0.53mm Max) and Ultra-Small PCB Footprint Area (1.08 x 0.68mm Max) Suitable for Compact Portable Electronics
- Provides ESD Protection per IEC 61000-4-2 Standard: Air  $\pm 20$ kV, Contact  $\pm 15$ kV
- One Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**
- Qualified to AEC-Q101 Standards for High Reliability**

## Mechanical Data

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208④
- Weight: 0.001 grams (Approximate)

**X1-DFN1006-2**



Bottom View



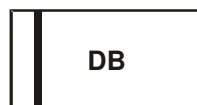
Device Schematic

## Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D20V0L1B2LP-7B	Commercial	DB	7	8	10,000/Tape & Reel

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  - See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  - For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



DB = Product Type Marking Code  
Line Denotes Pin 1

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P <sub>PP</sub>	68	W	8/20μs, See Figure 3
Peak Pulse Current	I <sub>PP</sub>	2.0	A	8/20μs, See Figure 3
ESD Protection – Contact Discharge	V <sub>ESD_CONTACT</sub>	±15	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V <sub>ESD_AIR</sub>	±20	kV	IEC 61000-4-2 Standard

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P <sub>D</sub>	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>θJA</sub>	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Conditions
Reverse Standoff Voltage	V <sub>RWM</sub>	—	—	20	V	—
Channel Leakage Current (Note 6)	I <sub>RM</sub>	—	—	100	nA	V <sub>RWM</sub> = 20V
Clamping Voltage, Positive Transients	V <sub>CL</sub>	—	27	30	V	I <sub>PP</sub> = 1A, t <sub>p</sub> = 8/20μS
		—	30	34	V	I <sub>PP</sub> = 2A, t <sub>p</sub> = 8/20μS
Breakdown Voltage	V <sub>BR</sub>	21	—	25	V	I <sub>R</sub> = 1mA
Differential Resistance	R <sub>DIF</sub>	—	2.2	—	Ω	I <sub>R</sub> = 1A, t <sub>p</sub> = 8/20μS
Channel Input Capacitance	C <sub>T</sub>	—	7.0	12	pF	V <sub>R</sub> = 0V, f = 1MHz

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. website at <http://www.diodes.com/package-outlines.html>.  
 6. Short duration pulse test used to minimize self-heating effect.

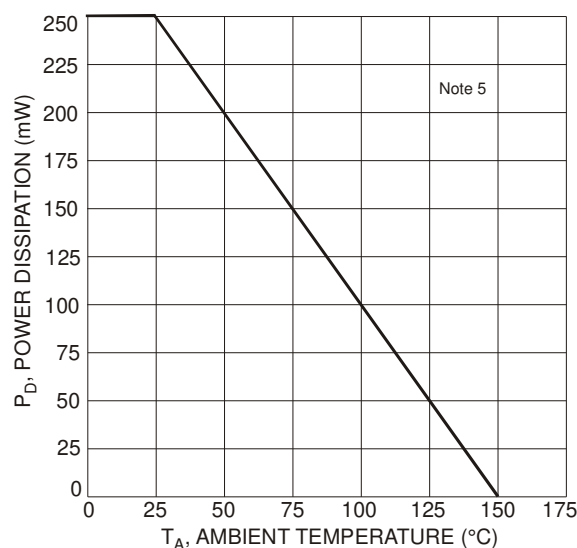


Figure 1 Power Derating Curve

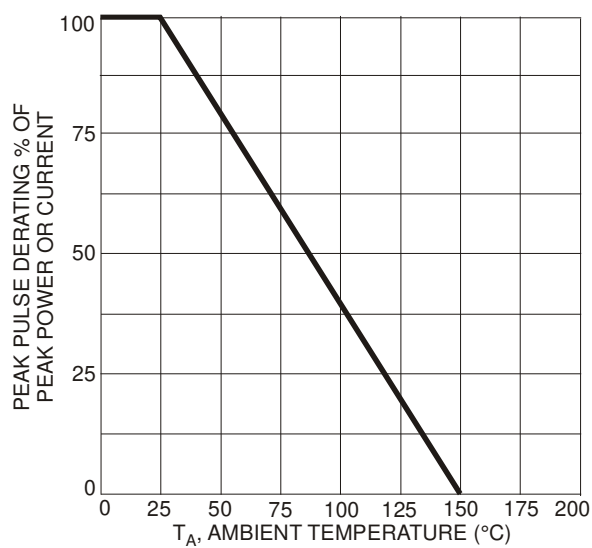
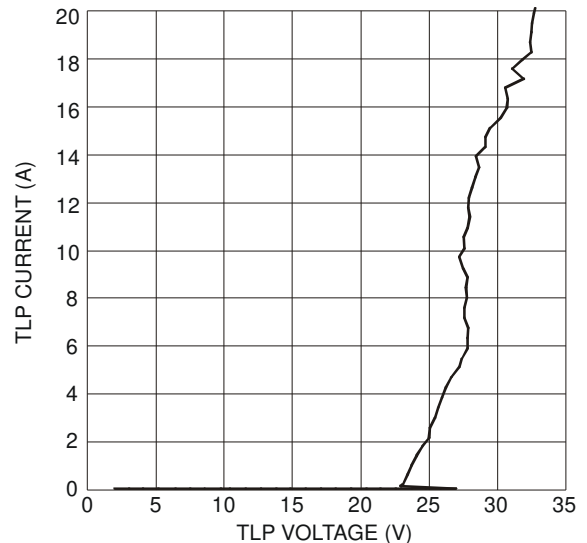
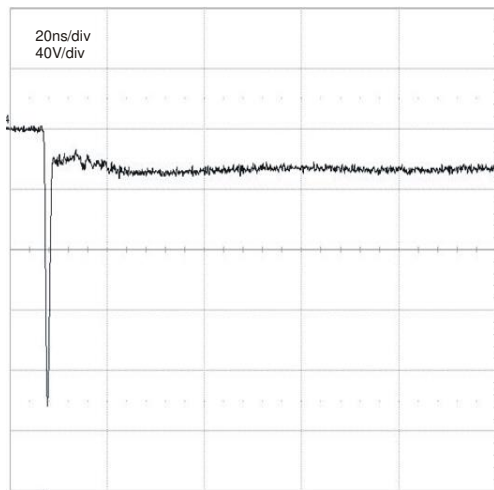
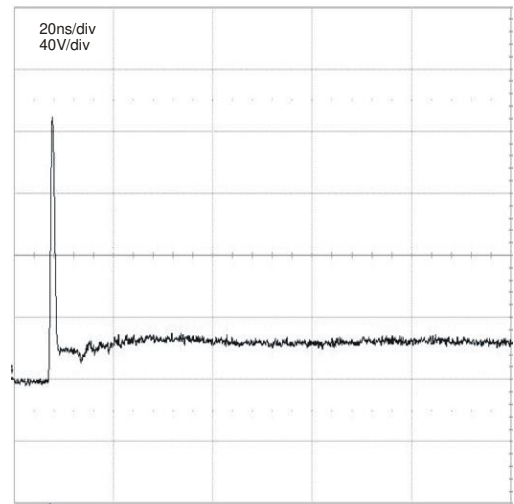
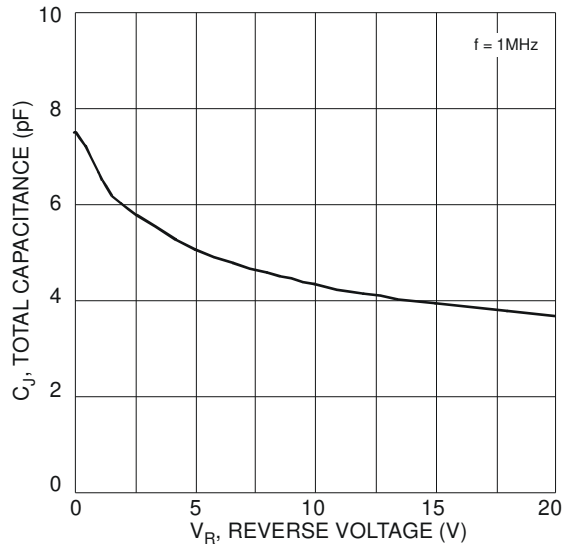
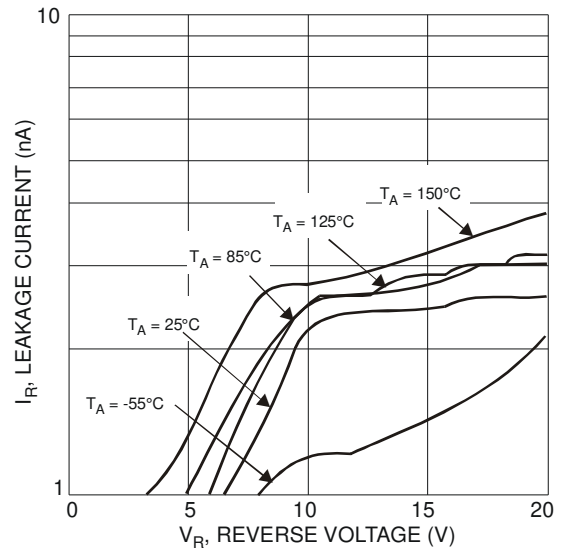
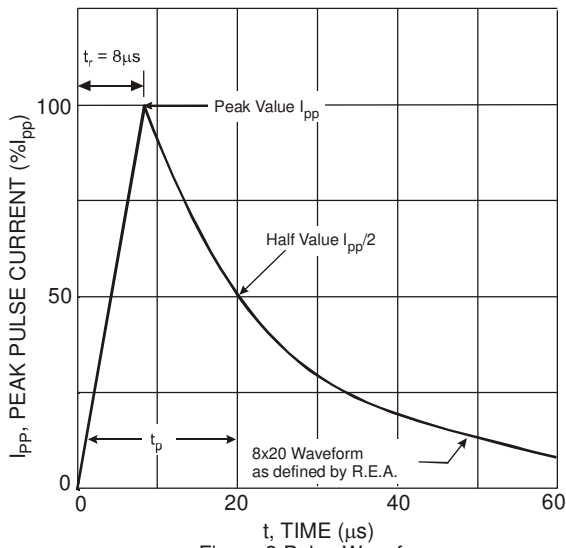


Figure 2 Pulse Derating Curve

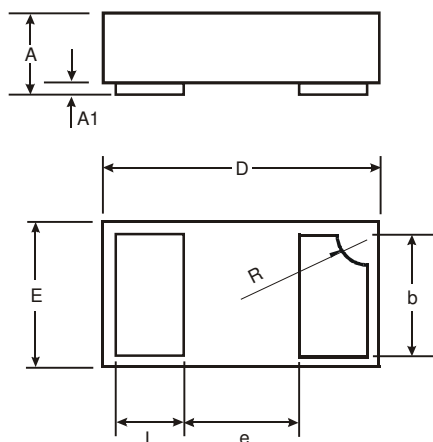




## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**X1-DFN1006-2**

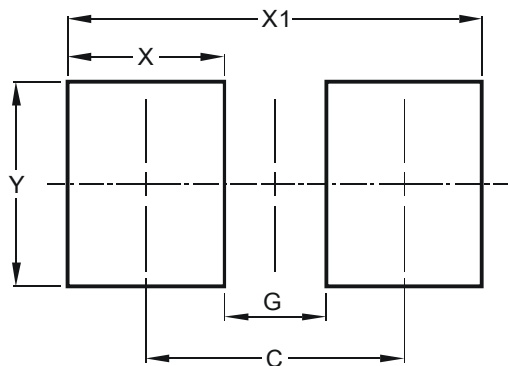


X1-DFN1006-2			
Dim	Min	Max	Typ
A	0.47	0.53	0.50
A1	0	0.05	0.03
b	0.45	0.55	0.50
D	0.95	1.075	1.00
E	0.55	0.675	0.60
e	—	—	0.40
L	0.20	0.30	0.25
R	0.05	0.15	0.10
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**X1-DFN1006-2**



Dimensions	Value (in mm)
C	0.70
G	0.30
X	0.40
X1	1.10
Y	0.70

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